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# FDH50N50 / FDA50N50

## N-Channel UniFET™ MOSFET

500 V, 48 A, 105 mΩ

### Features

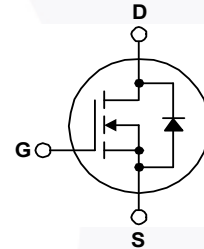
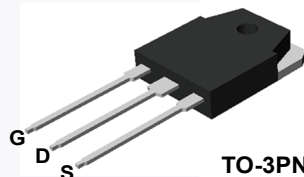
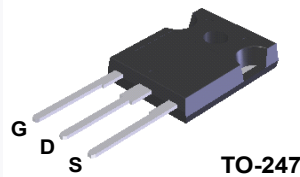
- $R_{DS(on)} = 89 \text{ m}\Omega$  (Typ.) @  $V_{GS} = 10 \text{ V}$ ,  $I_D = 24 \text{ A}$
- Low Gate Charge (Typ. 105 nC)
- Low  $C_{rss}$  (Typ. 45 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability

### Description

UniFET™ MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

### Applications

- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	FDH50N50_F133 / FDA50N50	Unit
$V_{DSS}$	Drain-Source Voltage	500	V
$I_D$	Drain Current	- Continuous ( $T_C = 25^\circ\text{C}$ )	48
		- Continuous ( $T_C = 100^\circ\text{C}$ )	30.8
$I_{DM}$	Drain Current	- Pulsed (Note 1)	192
$V_{GSS}$	Gate-Source voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	1868
$I_{AR}$	Avalanche Current	(Note 1)	48
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	62.5
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	20
$P_D$	Power Dissipation	( $T_C = 25^\circ\text{C}$ )	625
		- Derate Above $25^\circ\text{C}$	5
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	FDH50N50_F133 / FDA50N50	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.2	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDH50N50_F133	FDH50N50	TO-247	Tube	N/A	N/A	30 units
FDA50N50	FDA50N50	TO-3PN	Tube	N/A	N/A	30 units

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

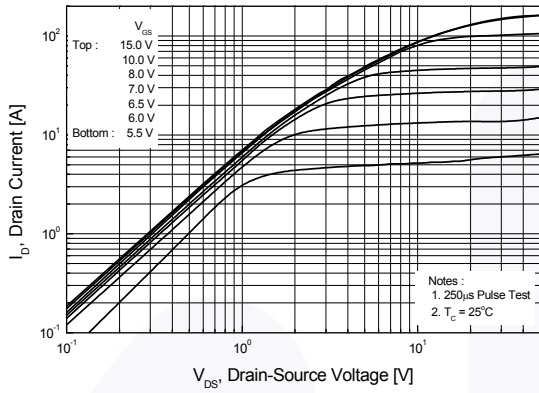
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	500	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.5	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$ $V_{DS} = 400\text{ V}, T_C = 125^\circ\text{C}$	--	--	25 250	$\mu\text{A}$ $\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA
<b>On Characteristics</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	3.0	--	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 24\text{ A}$	--	0.089	0.105	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 48\text{ A}$	--	20	--	S
<b>Dynamic Characteristics</b>						
$C_{ISS}$	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1\text{ MHz}$	--	4979	6460	pF
$C_{OSS}$	Output Capacitance		--	760	1000	pF
$C_{RSS}$	Reverse Transfer Capacitance		--	50	65	pF
$C_{OSS}$	Output Capacitance	$V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	--	161	--	pF
$C_{OSS(eff.)}$	Effective Output Capacitance	$V_{DS} = 0\text{ V to } 400\text{ V}, V_{GS} = 0\text{ V}$	--	342	--	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 250\text{ V}, I_D = 48\text{ A},$ $V_{GS} = 10\text{ V}, R_G = 25\ \Omega$	--	105	220	ns
$t_r$	Turn-On Rise Time		--	360	730	ns
$t_{d(off)}$	Turn-Off Delay Time		--	225	460	ns
$t_f$	Turn-Off Fall Time		(Note 4)	--	230	470
$Q_g$	Total Gate Charge	$V_{DS} = 400\text{ V}, I_D = 48\text{ A}$ $V_{GS} = 10\text{ V}$	--	105	137	nC
$Q_{gs}$	Gate-Source Charge		--	33	--	nC
$Q_{gd}$	Gate-Drain Charge		(Note 4)	--	45	--
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current		--	--	48	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current		--	--	192	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 48\text{ A}$	--	--	1.4	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 48\text{ A},$ $di_f/dt = 100\text{ A}/\mu\text{s}$	--	580	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	10	--	$\mu\text{C}$

### Notes:

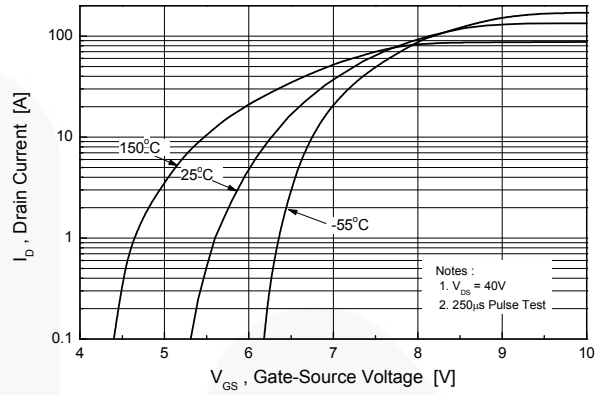
1. Repetitive rating; pulse-width limited by maximum junction temperature.
2.  $L = 1.46\text{ mH}, I_{AS} = 48\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 48\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature typical characteristics.

## Typical Performance Characteristics

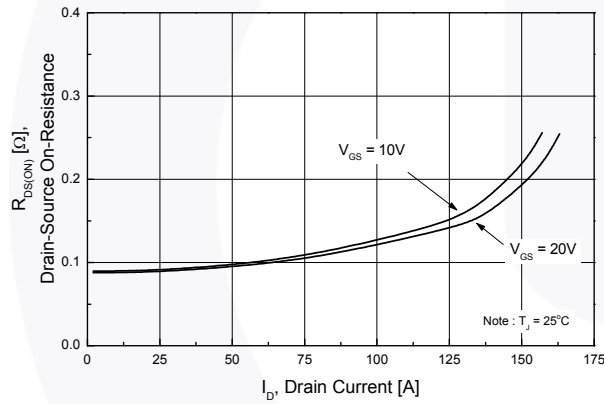
**Figure 1. On-Region Characteristics**



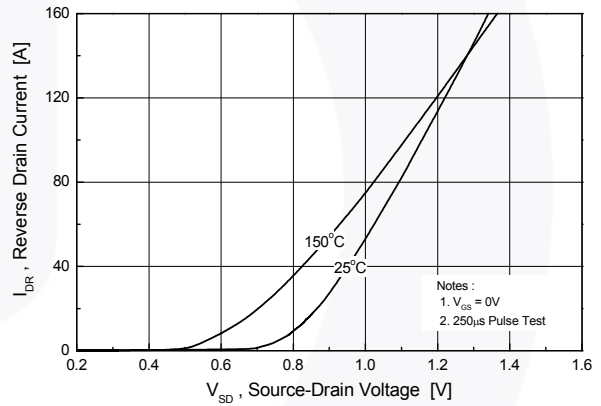
**Figure 2. Transfer Characteristics**



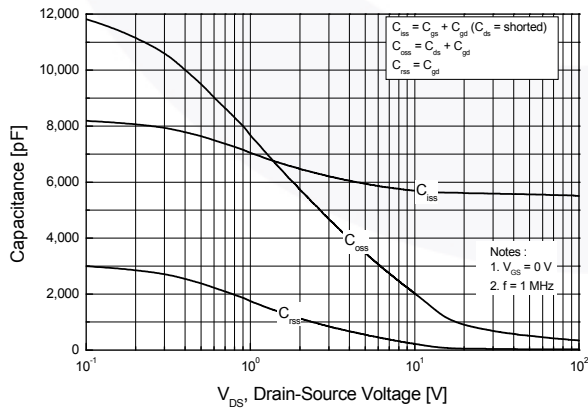
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



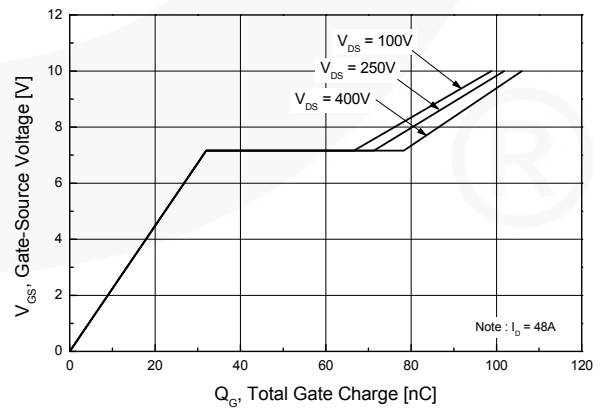
**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 5. Capacitance Characteristics**

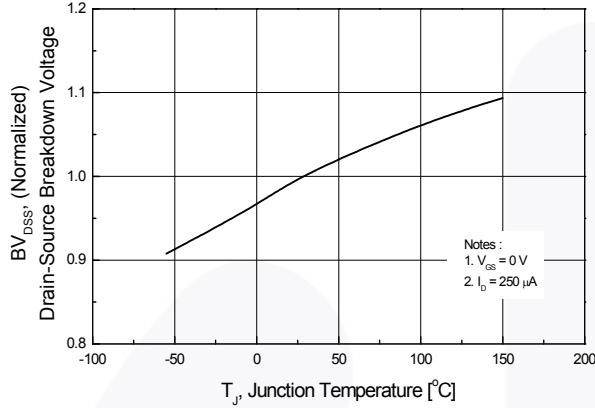


**Figure 6. Gate Charge Characteristics**

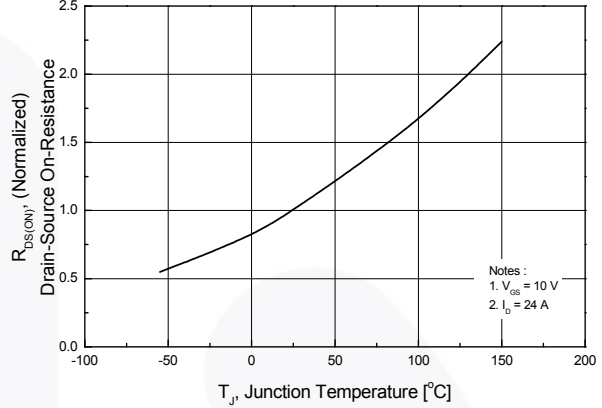


**Typical Performance Characteristics (Continued)**

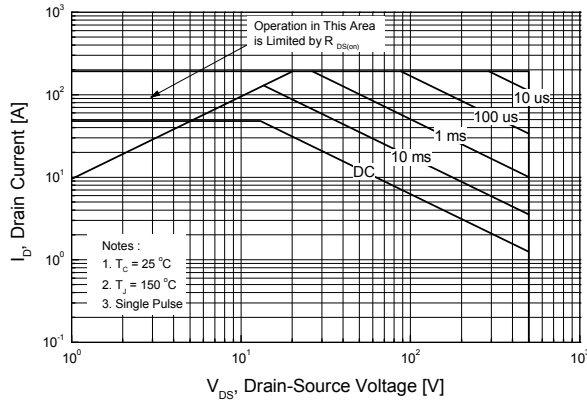
**Figure 7. Breakdown Voltage Variation vs. Temperature**



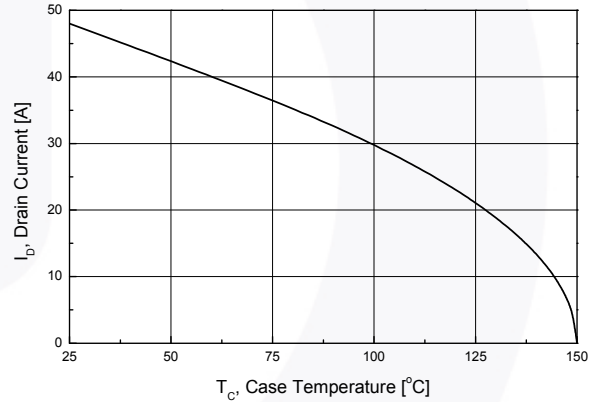
**Figure 8. On-Resistance Variation vs. Temperature**



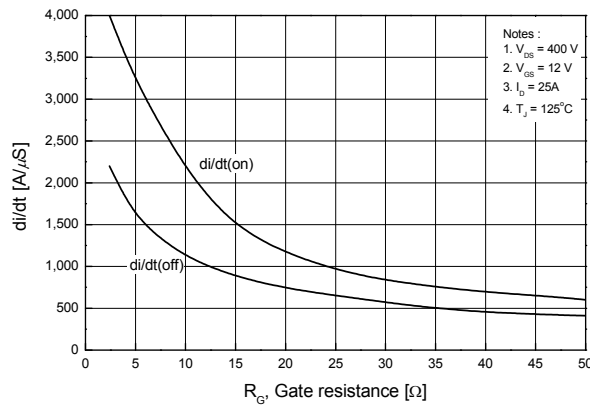
**Figure 9. Maximum Safe Operating Area**



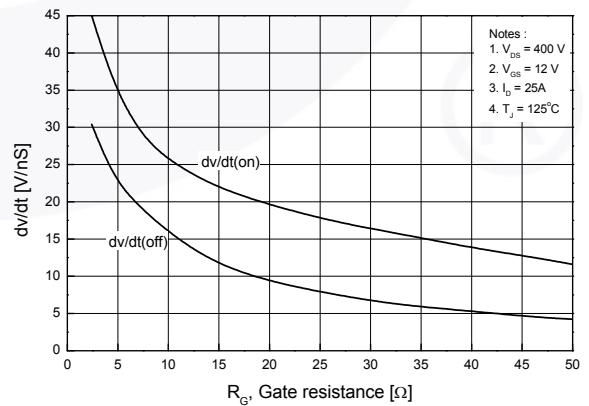
**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Typical Drain Current Slope vs. Gate Resistance**

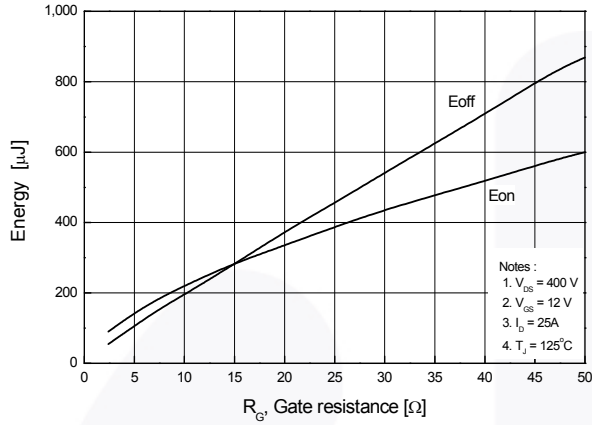


**Figure 12. Typical Drain-Source Voltage Slope vs. Gate Resistance**

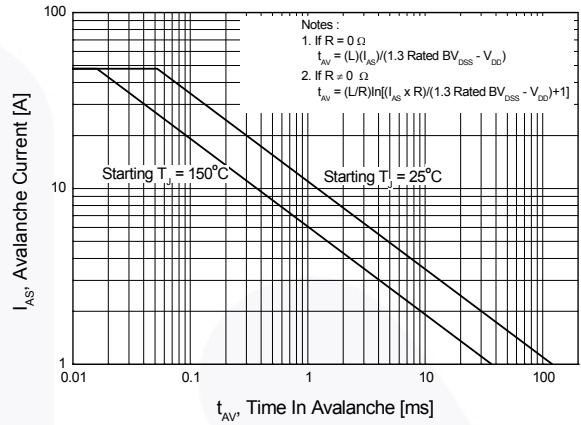


**Typical Performance Characteristics (Continued)**

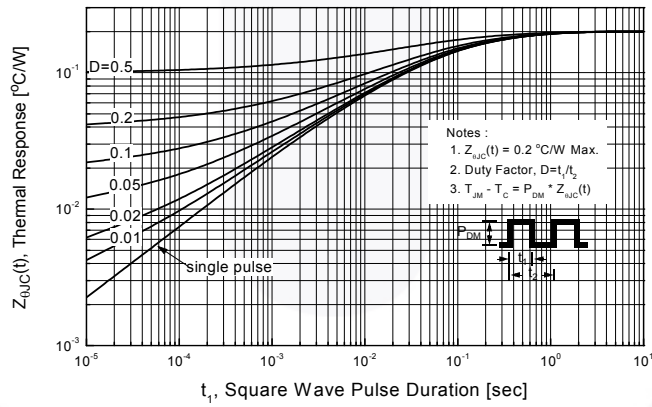
**Figure 13. Typical Switching Losses vs. Gate Resistance**



**Figure 14. Unclamped Inductive Switching Capability**



**Figure 15. Transient Thermal Resistance Curve**



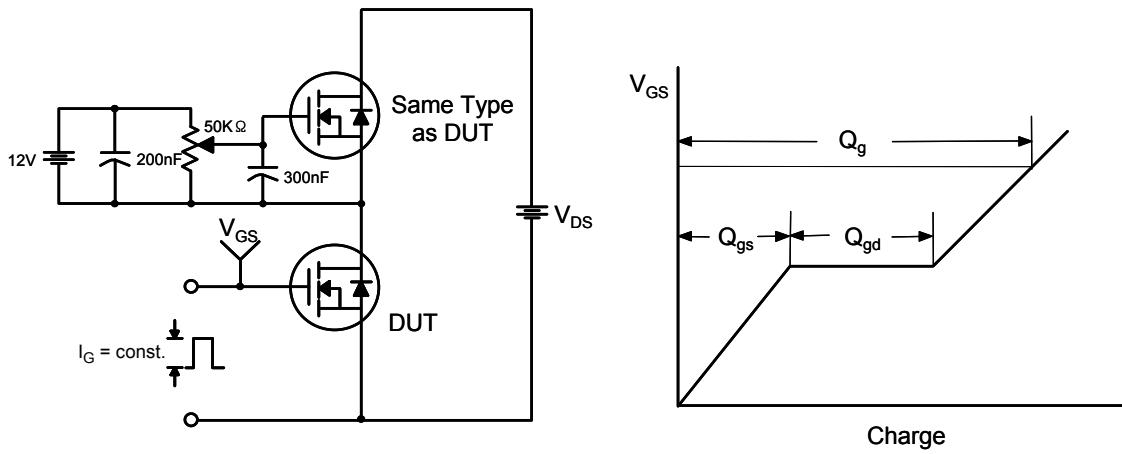


Figure 16. Gate Charge Test Circuit & Waveform



Figure 17. Resistive Switching Test Circuit & Waveforms



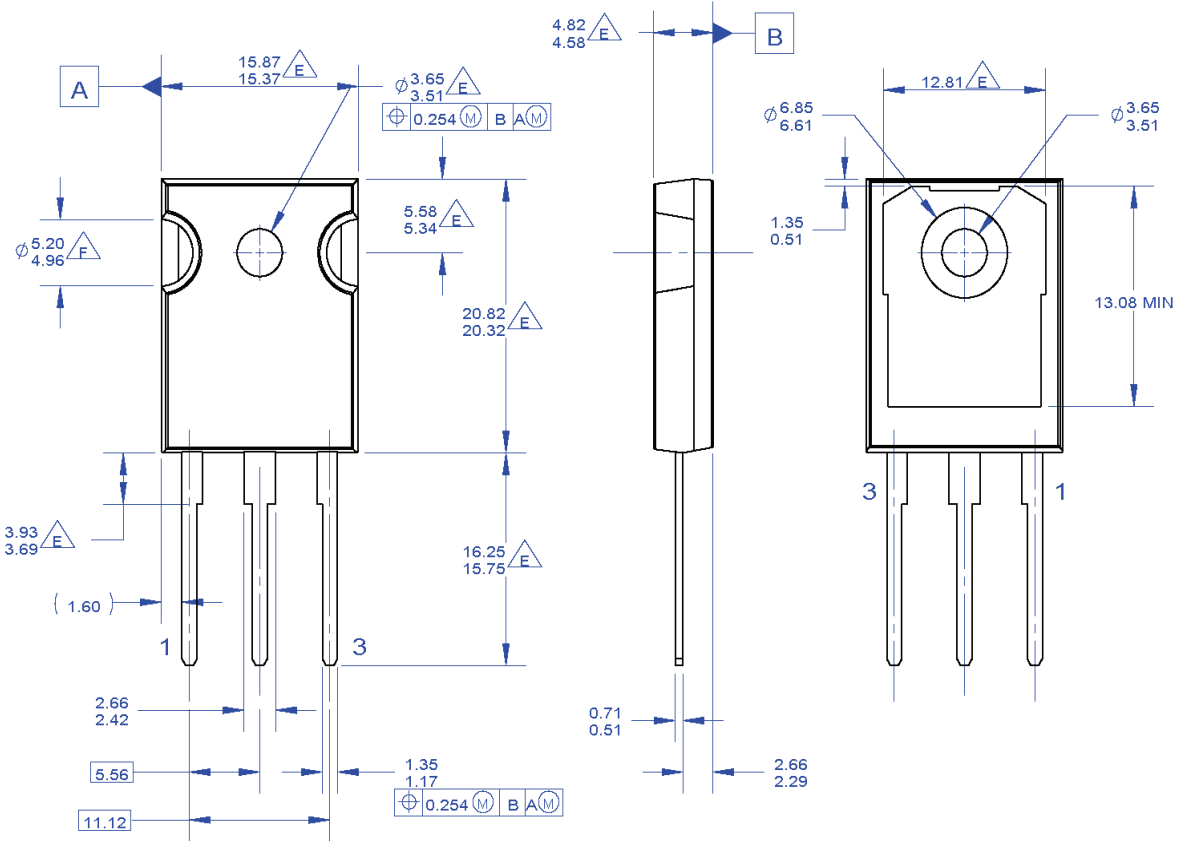
Figure 18. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 19. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms



## Mechanical Dimensions



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**Figure 20. TO-247, Molded, 3-Lead, Jedec Variation AB**

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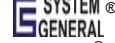



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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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